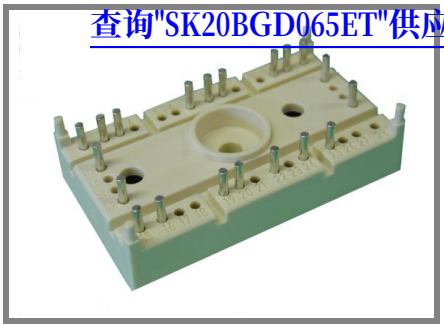
SK 20 BGD 065 ET



SEMITOP® 3

1-phase bridge rectifier
+3-phase bridge inverter

SK 20 BGD 065 ET

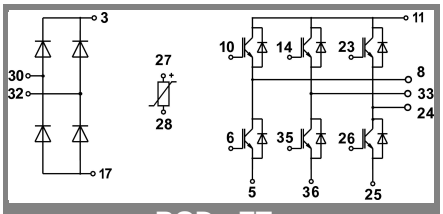
Target Data

Features

- Compact design
- One screw mounting
- Heat transfer and isolation through direct copper bonded alumium oxide ceramic (DCB)
- Ultrafast NPT technology IGBT
- CAL Technology FWD
- Integrated NTC temperature sensor

Typical Applications

- Inverter

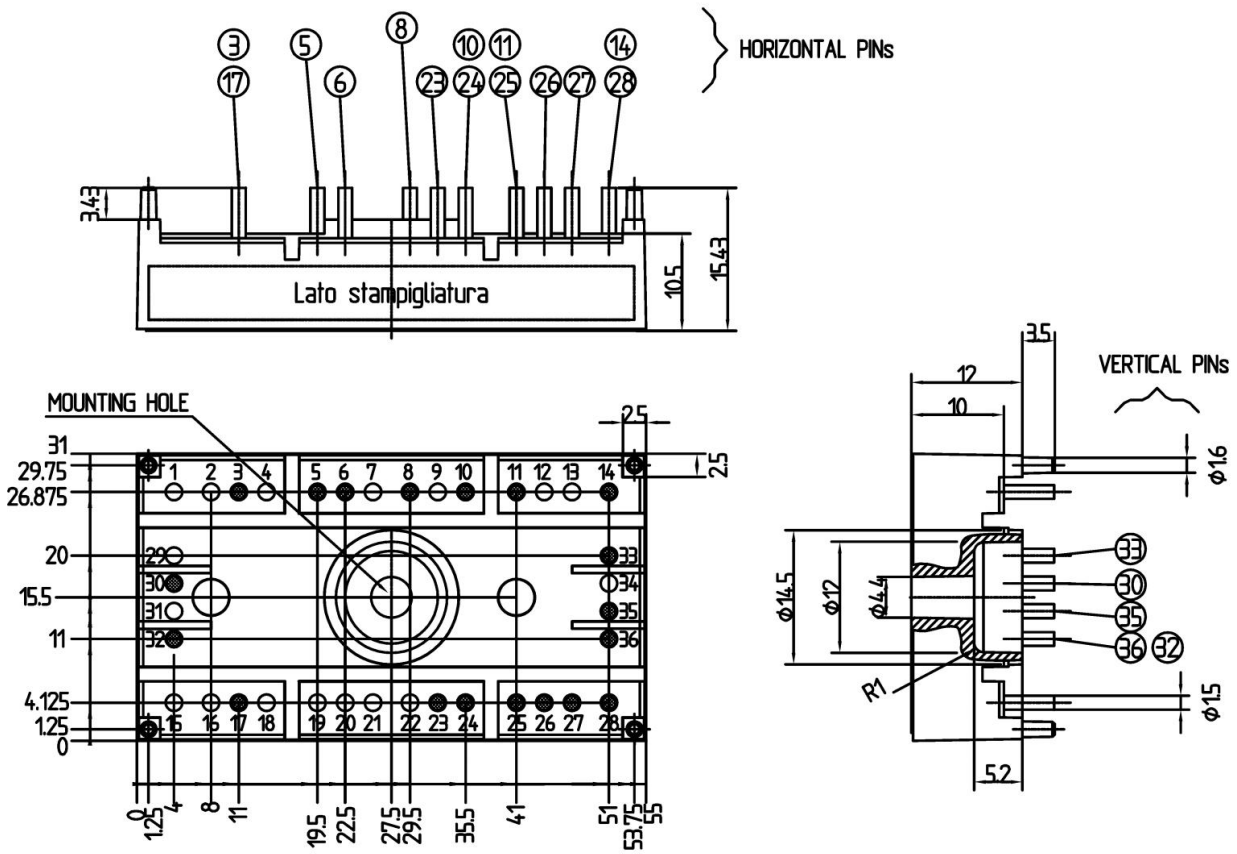


BGD - ET

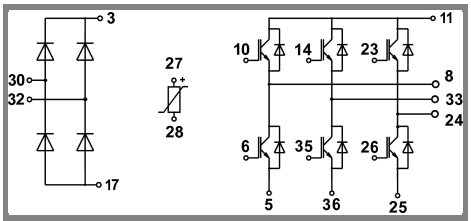
Absolute Maximum Ratings		T_s= 25°C, unless otherwise specified	
Symbol	**Conditions**	**Values**	**Units**
IGBT - Inverter			
V_{CES}		600	V
I_C	T_s = 25 (80) °C	24 (17)	A
I_{CM}	T_s = 25 (80) °C , tp ≤ 1 ms	48 (34)	A
V_{GES}		±20	V
T_j		-40 ... +150	°C
Diode - Inverter			
I_F	T_s = 25 (80) °C	25 (18)	A
I_{FM} = -I_{CM}	T_s = 25 (80) °C,tp ≤ 1 ms	50 (36)	A
T_j		-40 ... +150	°C
Rectifier			
V_{RRM}		800	V
I_{FAV} / I_{TAV}	T_s = 80 °C	20	A
I_{FSM} / I_{TSM}	t_p = 10 ms , sin 180 ° ,T_j = 25 °C	220	A
I^2t	t_p = 10 ms , sin 180 ° ,T_j = 25 °C	240	A²s
T_j		-40 ... +150	°C
T_{sol}	Terminals, 10s	260	°C
T_{stg}		-40 ... +125	°C
V_{isol}	AC, 1 min. / 1s	2500 / 3000	V

Characteristics		T_s= 25°C, unless otherwise specified			
Symbol	**Conditions**	**min.**	**typ.**	**max.**	**Units**
IGBT - Inverter					
V_{CEsat}	I_C = 20 A, T_j = 25 (125) °C		2 (2,2)	2,5	V
$V_{GE(th)}$	V_{GE} = V_{CE}, I_C = 0,5 mA	3	4	5	V
$V_{CE(TO)}$	T_j = °C () °C		1,2 (1,1)	1,3	V
r_T	T_j = °C () °C		40 (55)	60	mΩ
C_{ies}	V_{CE} = V_{GE} = 0 V, f = 1 MHz		1,2		nF
C_{oes}	V_{CE} = V_{GE} = 0 V, f = 1 MHz		-		nF
C_{res}	V_{CE} = V_{GE} = 0 V, f = 1 MHz		-		nF
$R_{th(j-s)}$	per IGBT			1,7	K/W
$t_{d(on)}$	under following conditions		-		ns
t_r	V_{CC} = 300 V, V_{GE} = ± 15 V		-		ns
$t_{d(off)}$	I_C = 20 A, T_j = 125 °C		-		ns
t_f	R_{Gon} = R_{Goff} = - Ω		-		ns
E_{on}	inductive load		0,6		mJ
E_{off}			0,44		mJ
Diode - Inverter					
V_F = V_{EC}	I_F = 20 A, T_j = 25 (125) °C		1,6 (1,6)		V
$V_{(TO)}$	T_j = °C (125) °C		1 (0,9)		V
r_T	T_j = °C (125) °C		30 (33)		mΩ
$R_{th(j-s)}$	per diode			1,7	K/W
I_{RRM}	under following conditions		-		A
Q_{rr}	I_F = A, V_R = V		-		µC
E_{rr}	V_{GE} = 0 V, T_j = 125 °C				mJ
	di_F/dt = - A/µs				
Diode rectifier					
V_F	I_F = 15 A, T_j = 25 °C		1,1		V
$V_{(TO)}$	T_j = 150 °C		0,8		V
r_T	T_j = 150 °C		20		mΩ
$R_{th(j-s)}$	per diode			2	K/W
Temperatur sensor					
R_{ts}	5 %, T_r = 25 (100) °C		5000(493)		Ω
Mechanical data					
w			30		g
M_s	Mounting torque			2,5	Nm

Dimensions in mm



Case T 61 (Suggested hole diameter, in the PCB, for solder pins and plastic mounting pins: 2mm)



Case T 61

This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

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